SIP Resistor Network



Custom Resistor Network Series

Features

- 1. The profiles of custom resistor network series products range from high profile (9.0mm) to low profile (5.0mm). All R-network needs can be accommodated.
- 2. High accuracy performance on resistance tolerance, temperature coefficient etc, is available with high technology and high grade materials.
- 3. Also, on the relative precision of the performance between resistor elements, the high accuracy is available.



■Standard Series



■Example Custom Circuits





Please read CAUTION and Notice in this catalog for safety. This catalog has only typical specifications. Therefore you are requested to approve our product specification or to transact the approval sheet for product specification, before your ordering.

■Rating

	RGHD Series	RGSD Series	RGLD Series	RGLE Series	
Power Rating Each Resistor *1	to 1/2W	to 1/4W		to 1/8W	
Total Rated Power *1	1/5×(Number of pins-1)W	1/8×(Number of pins-1)W		1/16×(Number of pins-1)W	
Rated Voltage *2	Rated voltage (V) = $\sqrt{Power rating (W) \times Nominal resistance value (\Omega)}$				
Resistance Range	10Ω to 10MΩ				
Resistance Tolerance	D : ±0.5%,(100Ω to 100kΩ), F : ±1%,(47Ω to 220kΩ), ±2% (22Ω Over), J : ±5%				
Resistance Value Ratio	±0.5%, ±1%, ±2% (Per customer's specifications)				
Temp.Coeff.of Resistance	±200ppm/°C (±100ppm/°C is also available)				
Max. Operating Voltage	to 500V				
Operating Temperature	-55 to +125°C				

*1 Derating Curve

The rated power per element and the total rated power are derated according to the following curve.



*2 When rated voltage exceeds the max. operating voltage, the max. operating voltage shall be regarded as the rated voltage.

Dimensions



■Marking



(1) Pin 1 identification
(2) Number of Resistors
(3) Type (Circuit) Designation

- (4) Murata's design No.
- (5) Manufacturer's Code
- (6) Date Code (Year, Month)



Performance and Test Method

	Test Item	Performance	Test Method					
			Based on JIS C 5202 5.1. Maximum applied voltage is shown in the table below.					
			Nominal Resistance Range(Ω)		Max. Applied Voltage (V)			
			<100	(0.3	_		
DC R	esistance value	Within the specified Value	100≦	R<1k		1	_	
		<u>1k≦R<10k</u>			3	_		
		10k≦R<100k		10	5	-		
		<u></u>		5	<u>ן</u> ז	-		
				= 1101		5	_	
			Based on JIS C 5202 5.2. Measure after maintaining for over 30 minutes at each stage shown in the table below, Calculation shall be made with the formula shown below.					
			Stage Terr	np.°C	Rema	rks		
			1 20± ⁵ Standard temp. on low-temp. side					
			2 -55	i±3				
Temp	erature	Within ±200ppm/℃	$\frac{3}{4}$ 20	$1\pm \frac{1}{2}$ Sta	andard temp. on	high-temp. s	ide	
Coeff	icient of		4 125	5				
Resis	tance		R : Actual me	asured resista	nce value(Ω) at t	t °C		
			Ro : Actual me	easured resista	nce value(Ω) at t	to ℃		
			t : Actual me	easured value o	of test temperatu	re (°C)		
			t_0 : Actual measured value of standard temperature (°C)					
		$TCR(ppm/C) = \frac{R-R_0}{R_0} \times \frac{1}{t-t_0} \times 10^6$						
		No noticeable abnormalities in						
Short	Time Overload	appearance.	Apply 2.5 times the rated voltage for 5 seconds to each resistor in the network, one at a time.					
choit hino cronodu		ΔR : Within ±1.0%	Maintain at room temperature for 30 minutes after remove the voltage, then measure.					
Pull Test Bend Test Bend Test		There shall be no broken or loose pins.	Fix the sample body and apply a load of 10N gradually to the pin in the axial direction. Maintain the force for 10 seconds.					
			Bend the pin by 90° in the vertical direction and return to the previous position under applying a load of 5N. And repeat a similar operation in the opposite direction.					
Resistance to Soldering Heat		There shall be neither mechanical damage nor noticeable change in appearance. ΔR : Within ±0.5%	Immerse the pin in melted solder at 260±5℃ up to the level of the seating plane of pin for 10±1 second and raise. Then maintain at room temperature for over 1 hour and measure.					
Solderability		Over 95% of the immersed part of	Immerse the pin in a flux comprising methanol and resin (weight ratio 25%) up to the level of the seating plane of pin for 5–10seconds. Then immerse in method solder at $235\pm5\%$ for					
		solder.	2±0.5 second and raise slowly.					
		There shall be no mechanical	Based on JIS C 5202 7.4 After repeating the 5 cycles shown in the table below, maintain at room temperature for $1-2$ hours, then measure.					
Tem	berature	damage.	Stage	1	2	3	4	
Cycling		ΔR : Within ±0.5%	Temp.(°C)	-55±3	Room Temp.	125±2	Room Temp.	
			Time (min.)	30	2 to 3	30	2 to 3	
Humidity T		There shall be no noticeable abnormalities in appearance. ΔR : Within ±2.0%	Maintain without load at a constant temperature $40\pm2^{\circ}$ and constant humidity of 90–95% for $1000\pm^{48}$ hours. Remove and maintain at room temperature for over 1 hour, then measure.					
Humidity Load		There shall be no noticeable abnormalities in appearance. ΔR : Within ±2.0%	Apply the rated voltage intermittently, 1.5 hours on and 0.5 hours off in a chamber at a constant temperature of 40 ± 2 °C and constant humidity of $90-95\%$ for $1000\pm^48$ hours. Remove and maintain at room temperature for over 1 hour, then measure.					
Load Life		There shall be no noticeable abnormalities in appearance. ΔR : Within ±2.0%	Apply the rated voltage intermittently, 1.5 hours on and 0.5 hours off in a high-temperature chamber at $70\pm3^{\circ}$ for $1000\pm^{4}8$ hours. Remove and maintain at room temperature for over 1 hour, then measure.					



Packaging

- 1. R-networks are available in two types of taping : 3-pin taping and all-pin taping.
- 2. 3-pin taping type is applicable to automatic insertion equivalent to 5mm pitch radial taping parts. The tips of untaped terminals are shaped by a V-cut for high accuracy insertion.

■Taping Dimensions



Standard Ammo Pack Package Quantity

1000pcs./case

■Package and Marking

• H, L (Height and Length)

Туре	Number of pins	Н	L	
T1	5 to 8	200	40	
	9 to 10	290	40	
T2	4 to 9	210	45	

(in mm)



Minimum Quantity 1000pcs.





∴Caution/Notice

■ ① Caution

Use within rated voltage

To avoid resistor burning or breakdown, do not use beyond the rated voltage calculated by taking the square root of the product or rated power and nominal resistance value.

■Notice

- Handling after mounting to PCB Do not bend the product after mounting and soldering the product. If subjected to mechanical stress, the resistor may become damaged.
- 2. Confirmation of resistor operation in application Ensure proper performance of the product in your application.
- 3. Environmental conditions

Do not use or store the product in locations containing corrosive gasses (Cl₂, H₂S, NH₃, SO₂, NO_x, etc.) or having such high humidity as will dew as the product's resin coating does not form a perfect seal.

